CLAIMS:

This listing of claims will replace all prior versions, and listings, of claims in the application:

- 1. (Currently Amended) A resinous interior material comprising 10 to 45 parts by mass of an ethylene/vinyl acetate copolymer, 10 to 90 parts by mass of a polyolefin resin, 10 to 90 parts by mass of either a block copolymer of styrene and one or more aliphatic unsaturated hydrocarbon compounds or a product of hydrogenation of the copolymer (hereinafter referred to as styrene/(poly)olefin block copolymer), and 100 to 700 parts by mass of an inorganic filler, wherein the ethylene/vinyl acetate copolymer has a vinyl acetate concentration of 50% or higher, the ethylene/vinyl acetate copolymer has a melt flow rate (hereinafter referred to as MFR) which is higher by at least 20 g/10 min than MFR's of other resins, and the styrene/(poly)olefin block copolymer has a glass transition temperature (T_g or tanδ absorption) [[of]] for the polystyrene block and a glass transition temperature for the (poly)olefin block, wherein at least one of the glass transition temperatures is from -20°C to +50°C.
 - 2. (Canceled)
 - 3. (Canceled)
- 4. (Previously Presented) The resinous interior material as claimed in claim 1, wherein the aliphatic unsaturated hydrocarbon compounds in the styrene/(poly)olefin block copolymer comprise an aliphatic unsaturated hydrocarbon compound having 3 or more carbon atoms.
- 5. (Currently Amended) A flooring material produced by compounding 10 to 50 parts by mass of an ethylene/vinyl acetate copolymer having a vinyl acetate concentration of 50% or higher and an MFR of 40 to 100 g/10 min with 10 to 90 parts by mass of a polyolefin resin having an MFR of 1 to 20 g/10 min, 10 to 90 parts by mass of a

styrene/(poly)olefin block copolymer having a glass transition temperature [[of]] for the polystyrene block and a glass transition temperature for the (poly)olefin block, wherein at least one of the glass transition temperatures is from -10°C to +40°C and an MFR of 1 to 20 g/10 min, and 400 to 700 parts by mass of an inorganic filler and molding the resultant composition into a single-layer structure,

- 6, (Original) The flooring material as claimed in claim 5, wherein a copolymer of methyl methacrylate and an acrylic ester is further compounded in an amount of 10 to 50 parts by mass.
- 7. (Previously Presented) The flooring material as claimed in claim 5, wherein an ethylene/acrylic ester/maleic anhydride terpolymer is further compounded in an amount of 10 to 30 parts by mass.
- 8. (Previously Presented) The flooring material as claimed in claim 5, wherein a tackifier is further compounded in an amount of 1 to 30 parts by mass.
- 9. (Previously Presented) The flooring material as claimed in claim 5, which is a flooring tile.
- 10. (Currently Amended) A skirting board produced through compounding 10 to 45 parts by mass of an ethylene/vinyl acetate copolymer having a vinyl acetate concentration of 50% or higher and an MFR of 40 to 100 g/10 min with 10 to 90 parts by mass of a polyolefin resin having an MFR of 1 to 20 g/10 min, 10 to 90 parts by mass of a styrene/(poly)olefin block copolymer having a glass transition temperature [[of]] for the polystyrene block and a glass transition temperature for the (poly)olefin block, wherein at least one of the glass transition temperatures is from -10°C to +40°C and an MFR of 1-20 g/10 min, and 150 to 400 parts by mass of an inorganic filler.

- 11. (Original) The skirting board as claimed in claim 10, wherein an ethylene/maleic anhydride copolymer or an ethylene/methacrylic acid copolymer is further compounded in an amount of 1 to 30 parts by mass.
- 12. (Previously Presented) The skirting board as claimed in claim 10, wherein a tackifier is further compounded in an amount of 1 to 30 parts by mass.
- 13. (Previously Presented) The skirting board as claimed in claim 10, which has a surface layer formed by superposing an ionomer resin.
- 14. (Previously Presented) The skirting board as claimed in claim 10, which has a surface layer formed by superposing a nylon resin.